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In Re Application of:)	
)	
Chen, et al.)	Confirmation No.: 9818
)	
Serial No.: 10/810,965)	Examiner: Trinh, Hoa B.
)	
Filed: March 26, 2004)	Group Art Unit: 2814
)	
For: Novel Method to Improve Bump Reliability for)	TKHR Docket: 252016-2530
Flip Chip Device)	Top-Team: 0503-A30731US

CERTIFICATE OF FACSIMILE TRANSMISSION UNDER 37 CFR §1.8

I hereby certify that this paper (along with any paper referred to as being attached or enclosed) is being transmitted on the date indicated below via facsimile to the United States Patent and Trademark Office, Technology Group 2100, facsimile number (571) 273-8300. Total number of pages in this transmission 12.

January 30, 2006

Date


Daniel R. McClure**AMENDMENT AND RESPONSE TO OFFICE ACTION**

Mail Stop Amendment
Commissioner for Patents
P.O. Box 1450
Alexandria, Virginia 22313-1450

Sir:

The Office Action mailed November 15, 2005 has been carefully considered. In response thereto, please enter the following amendments and consider the following remarks.

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